

## NCE N-Channel Enhancement Mode Power MOSFET

### Description

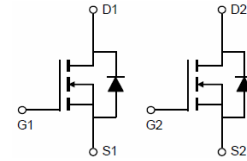
The NCE6802 uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge. This device is suitable for use as a load switch or in PWM applications.

### General Features

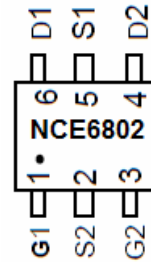
- $V_{DS} = 30V, I_D = 3.5A$   
 $R_{DS(ON)} < 73m\Omega @ V_{GS}=4.5V$   
 $R_{DS(ON)} < 46m\Omega @ V_{GS}=10V$
- High power and current handling capability
- Lead free product is acquired
- Surface mount package

### Application

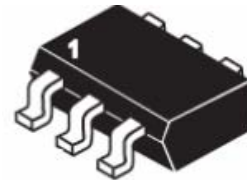
- Battery protection
- Load switch
- Power management



Schematic diagram



Marking and pin Assignment



SOT23-6L top view

### Package Marking and Ordering Information

| Device Marking | Device  | Device Package | Reel Size | Tape width | Quantity   |
|----------------|---------|----------------|-----------|------------|------------|
| NCE6802        | NCE6802 | SOT-23-6L      | Ø180mm    | 8 mm       | 3000 units |

### Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

| Parameter  | Symbol         | Limit      | Unit       |
|--|----------------|------------|------------|
| Drain-Source Voltage                             | $V_{DS}$       | 30         | V          |
| Gate-Source Voltage                              | $V_{GS}$       | $\pm 20$   | V          |
| Drain Current-Continuous                         | $I_D$          | 3.5        | A          |
| Drain Current-Pulsed <sup>(Note 1)</sup>         | $I_{DM}$       | 20         | A          |
| Maximum Power Dissipation                        | $P_D$          | 1.2        | W          |
| Operating Junction and Storage Temperature Range | $T_J, T_{STG}$ | -55 To 150 | $^\circ C$ |

### Thermal Characteristic

|   |                 |     |              |
|---|-----------------|-----|--------------|
| Thermal Resistance, Junction-to-Ambient <sup>(Note 2)</sup> | $R_{\theta JA}$ | 104 | $^\circ C/W$ |
|---|-----------------|-----|--------------|

### Electrical Characteristics ( $T_A=25^\circ C$ unless otherwise noted)

| Parameter                       | Symbol     | Condition                 | Min | Typ | Max | Unit    |
|---------------------------------|------------|---------------------------|-----|-----|-----|---------|
| <b>Off Characteristics</b>      |            |                           |     |     |     |         |
| Drain-Source Breakdown Voltage  | $BV_{DSS}$ | $V_{GS}=0V, I_D=250\mu A$ | 30  | 33  | -   | V       |
| Zero Gate Voltage Drain Current | $I_{DSS}$  | $V_{DS}=30V, V_{GS}=0V$   | -   | -   | 1   | $\mu A$ |

|  |              |  |     |      |           |            |
|--|--------------|--|-----|------|-----------|------------|
| Gate-Body Leakage Current                            | $I_{GSS}$    | $V_{GS}=\pm 20V, V_{DS}=0V$                                  | -   | -    | $\pm 100$ | nA         |
| <b>On Characteristics</b> <sup>(Note 3)</sup>        |              |  |     |      |           |            |
| Gate Threshold Voltage                               | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$                                | 1.2 | 1.5  | 2.2       | V          |
| Drain-Source On-State Resistance                     | $R_{DS(ON)}$ | $V_{GS}=10V, I_D=3.5A$                                       | -   | 36   | 45        | m $\Omega$ |
|  |              | $V_{GS}=4.5V, I_D=2A$  | -   | 59   | 70        | m $\Omega$ |
| Forward Transconductance                             | $g_{FS}$     | $V_{DS}=5V, I_D=3.5A$  | -   | 12   | -         | S          |
| <b>Dynamic Characteristics</b> <sup>(Note4)</sup>    |              |  |     |      |           |            |
| Input Capacitance                                    | $C_{iss}$    | $V_{DS}=15V, V_{GS}=0V,$<br>$F=1.0MHz$                       | -   | 170  | -         | PF         |
| Output Capacitance                                   | $C_{oss}$    |  | -   | 35   | -         | PF         |
| Reverse Transfer Capacitance                         | $C_{rss}$    |  | -   | 23   | -         | PF         |
| <b>Switching Characteristics</b> <sup>(Note 4)</sup> |              |  |     |      |           |            |
| Turn-on Delay Time                                   | $t_{d(on)}$  | $V_{DS}=15V, R_L=4.2\Omega$<br>$V_{GS}=10V, R_{GEN}=3\Omega$ | -   | 4.5  | -         | nS         |
| Turn-on Rise Time                                    | $t_r$        |  | -   | 1.5  | -         | nS         |
| Turn-Off Delay Time                                  | $t_{d(off)}$ |  | -   | 18.5 | -         | nS         |
| Turn-Off Fall Time                                   | $t_f$        |  | -   | 15.5 | -         | nS         |
| Total Gate Charge                                    | $Q_g$        | $V_{DS}=15V, I_D=3.5A,$<br>$V_{GS}=10V$                      | -   | 4.0  | -         | nC         |
| Gate-Source Charge                                   | $Q_{gs}$     |  | -   | 0.75 | -         | nC         |
| Gate-Drain Charge                                    | $Q_{gd}$     |  | -   | 0.65 | -         | nC         |
| <b>Drain-Source Diode Characteristics</b>            |              |  |     |      |           |            |
| Diode Forward Voltage <sup>(Note 3)</sup>            | $V_{SD}$     | $V_{GS}=0V, I_S=3.5A$  | -   | 0.8  | 1.2       | V          |
| Diode Forward Current <sup>(Note 2)</sup>            | $I_S$        |  | -   | -    | 3.5       | A          |

### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production

Typical Electrical and Thermal Characteristics

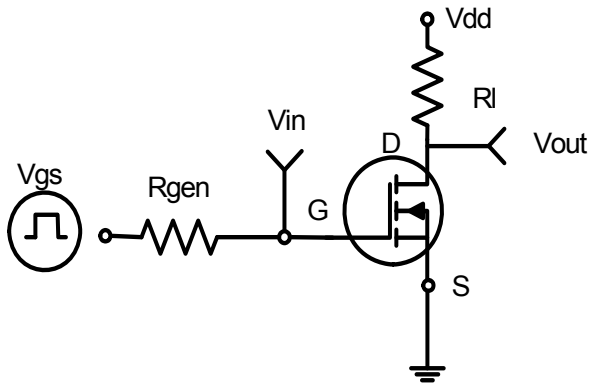


Figure 1: Switching Test Circuit



Figure 2: Switching Waveforms

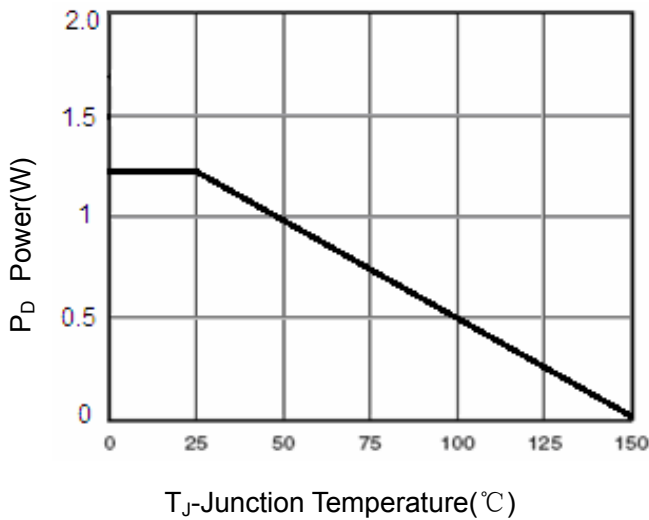


Figure 3 Power Dissipation

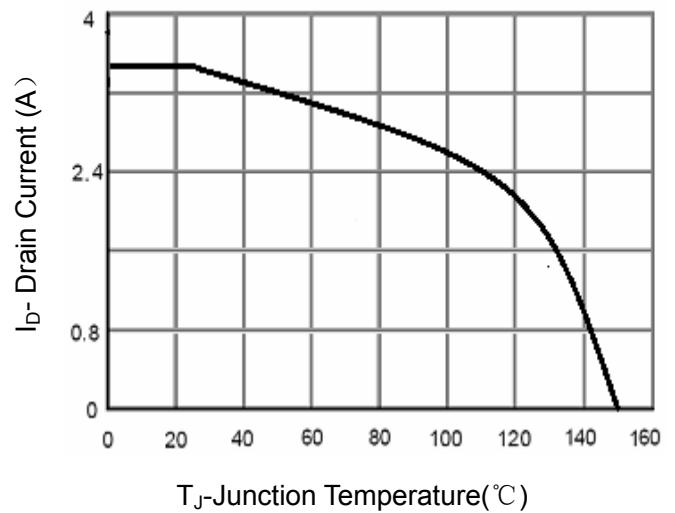


Figure 4 Drain Current

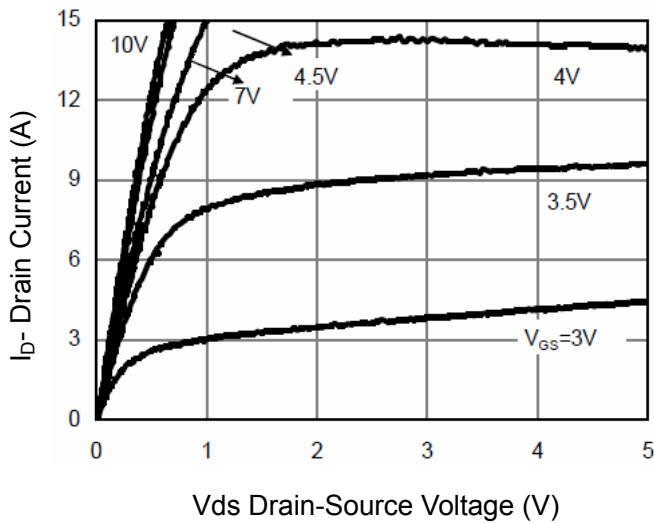


Figure 5 Output Characteristics

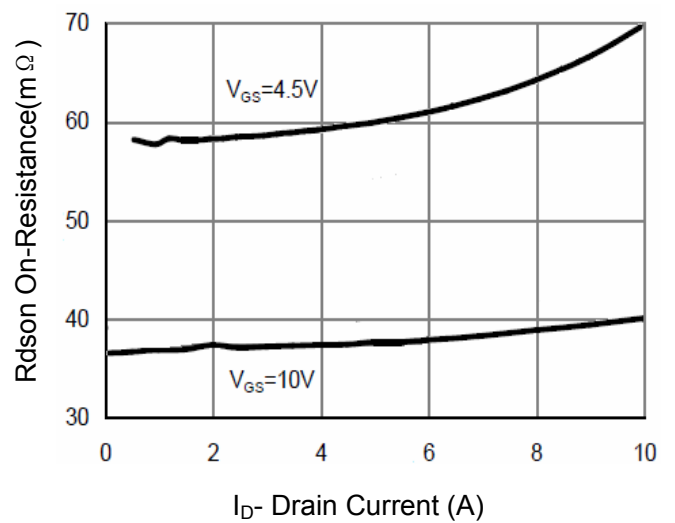


Figure 6 Drain-Source On-Resistance

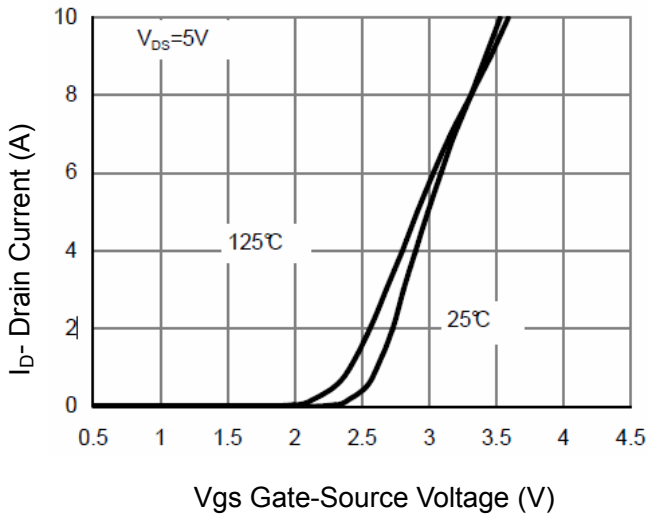


Figure 7 Transfer Characteristics

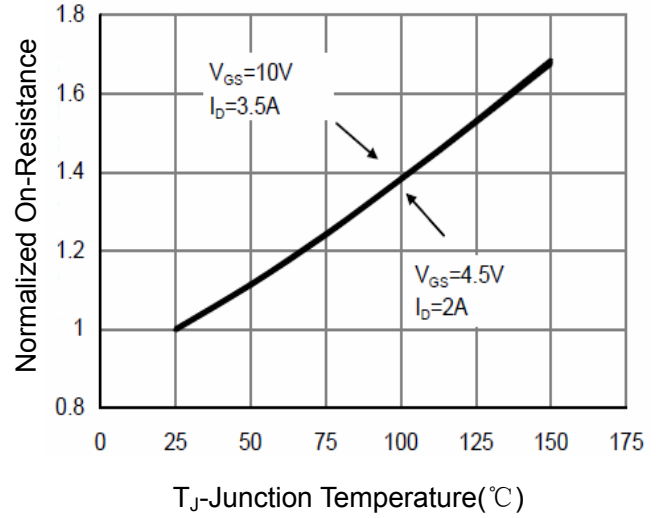


Figure 8 Drain-Source On-Resistance

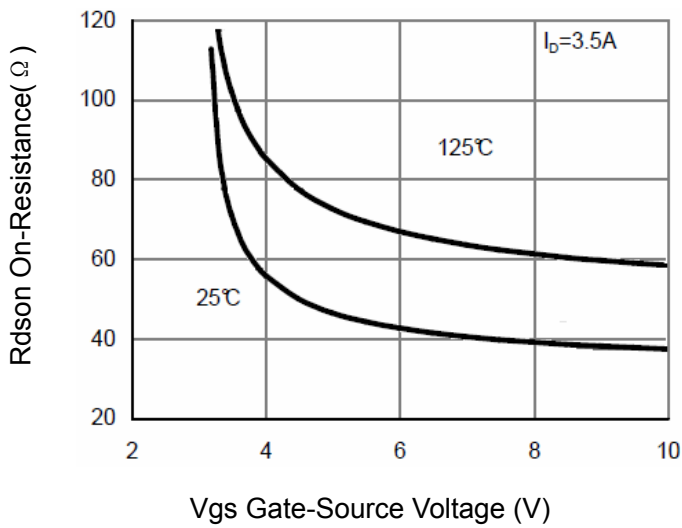


Figure 9 Rdson vs Vgs

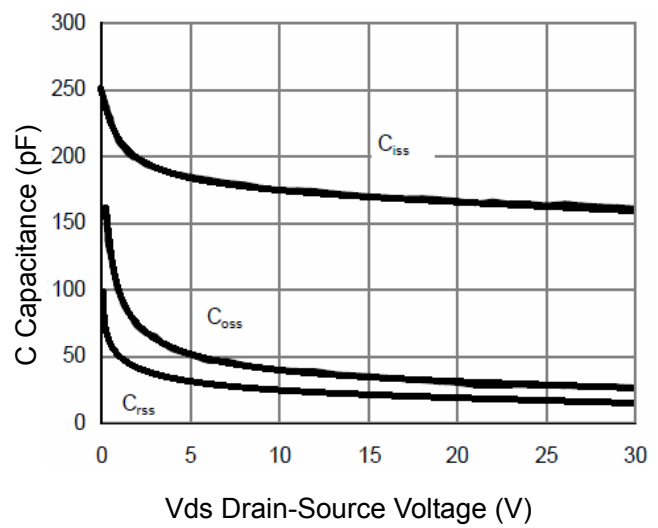


Figure 10 Capacitance vs Vds

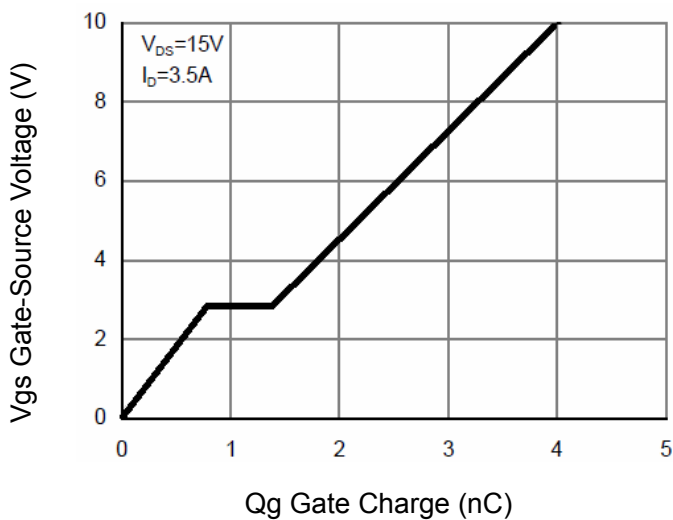


Figure 11 Gate Charge

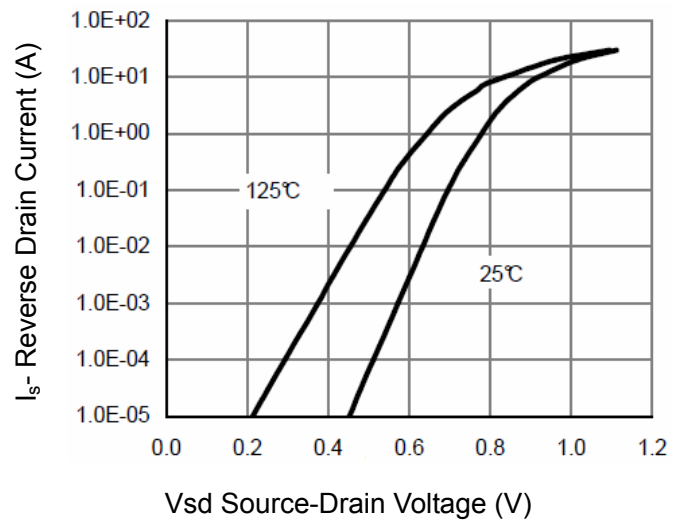


Figure 12 Source- Drain Diode Forward

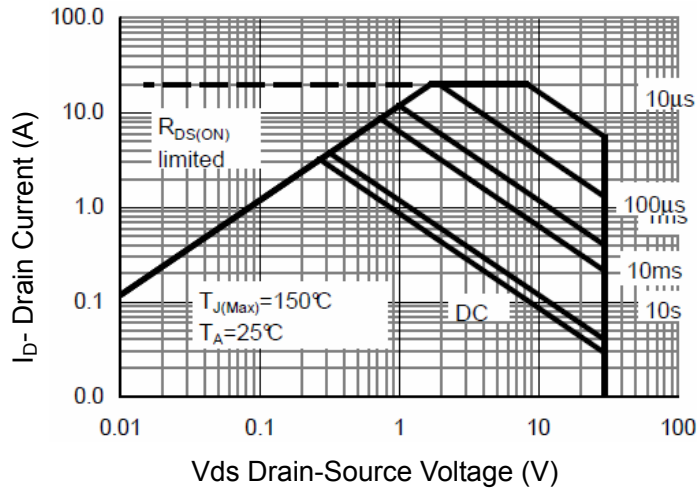


Figure 13 Safe Operation Area

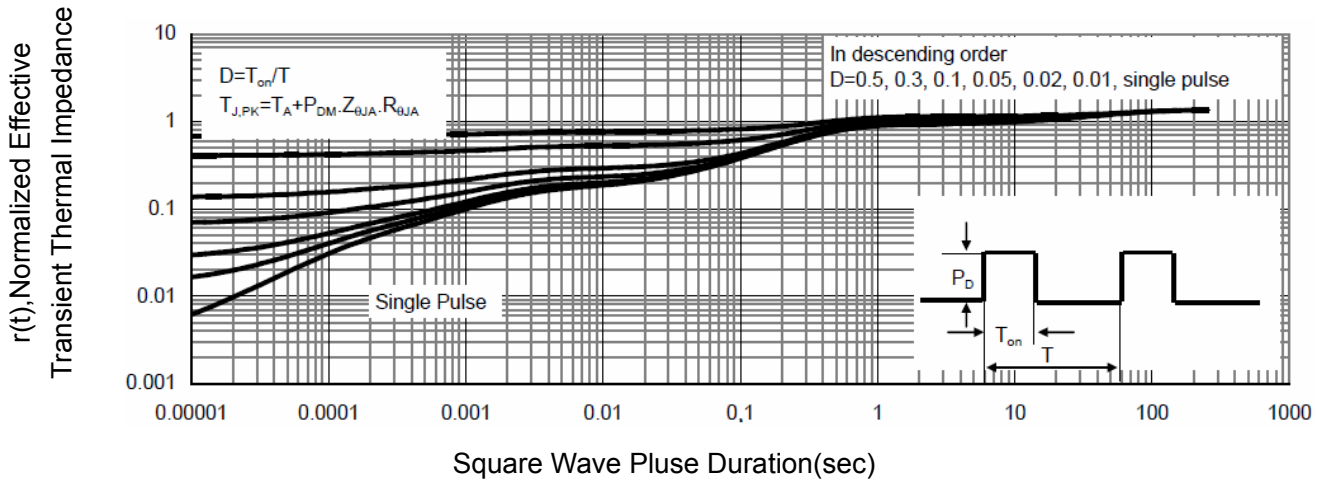
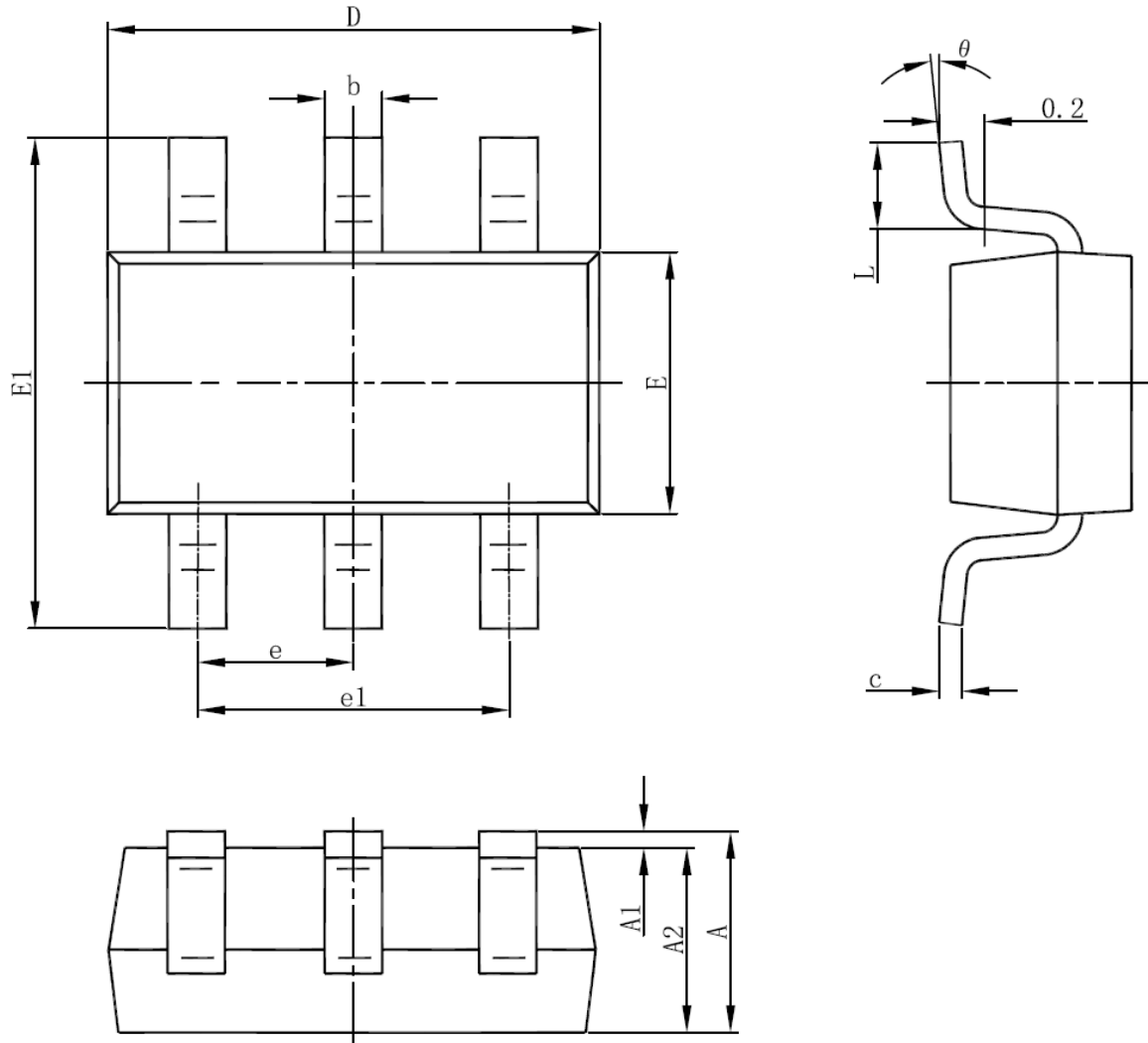


Figure 14 Normalized Maximum Transient Thermal Impedance

## SOT23-6L Package Information



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min                       | Max   | Min                  | Max   |
| A      | 1.050                     | 1.250 | 0.041                | 0.049 |
| A1     | 0.000                     | 0.100 | 0.000                | 0.004 |
| A2     | 1.050                     | 1.150 | 0.041                | 0.045 |
| b      | 0.300                     | 0.500 | 0.012                | 0.020 |
| c      | 0.100                     | 0.200 | 0.004                | 0.008 |
| D      | 2.820                     | 3.020 | 0.111                | 0.119 |
| E      | 1.500                     | 1.700 | 0.059                | 0.067 |
| E1     | 2.650                     | 2.950 | 0.104                | 0.116 |
| e      | 0.950(BSC)                |       | 0.037(BSC)           |       |
| e1     | 1.800                     | 2.000 | 0.071                | 0.079 |
| L      | 0.300                     | 0.600 | 0.012                | 0.024 |
| θ      | 0°                        | 8°    | 0°                   | 8°    |

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